

General Description

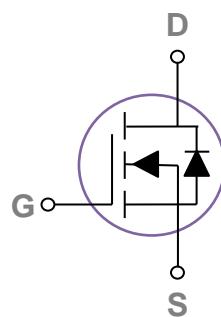
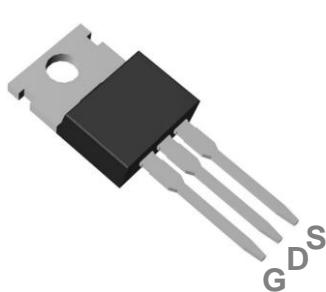
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
40V	2.5mΩ	170A

Features

- 40V, 170A, RDS(ON) = 2.5mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

TO220 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _{Gs}	Gate-Source Voltage	±20	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	170	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	109	A
I _{DM}	Drain Current – Pulsed ¹	680	A
EAS	Single Pulse Avalanche Energy ²	312	mJ
IAS	Single Pulse Avalanche Current ²	79	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	151	W
	Power Dissipation – Derate above 25°C	1.2	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	0.83	°C/W

Electrical Characteristics ($T_J=25\text{ }^{\circ}\text{C}$, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	40	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=40\text{V}$, $V_{GS}=0\text{V}$, $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	μA
		$V_{DS}=32\text{V}$, $V_{GS}=0\text{V}$, $T_J=100\text{ }^{\circ}\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$, $I_D=20\text{A}$	---	2.1	2.5	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$	2	3	4	V
g_{fs}	Forward Transconductance	$V_{DS}=10\text{V}$, $I_S=3\text{A}$	---	11	---	S

Dynamic and switching Characteristics

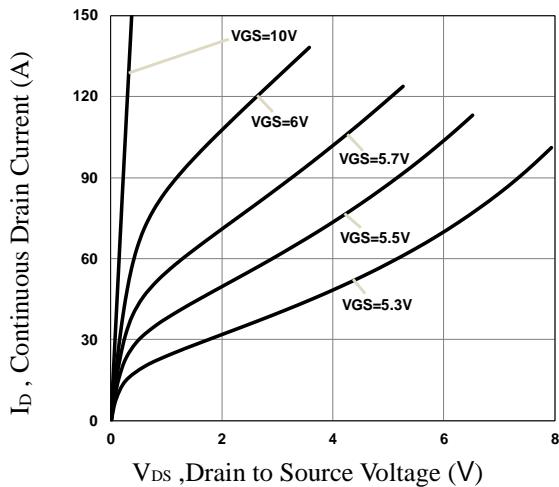
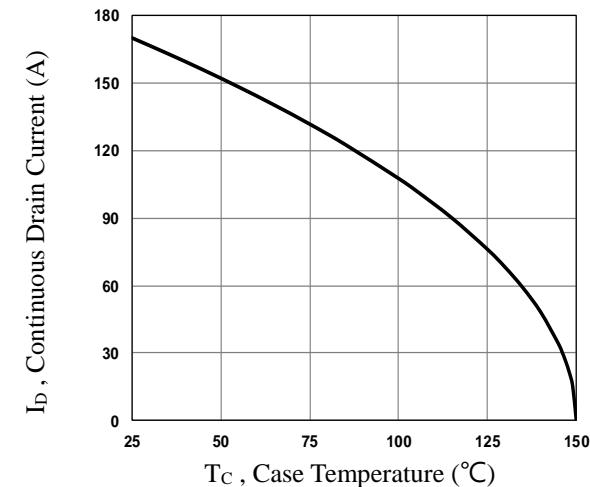
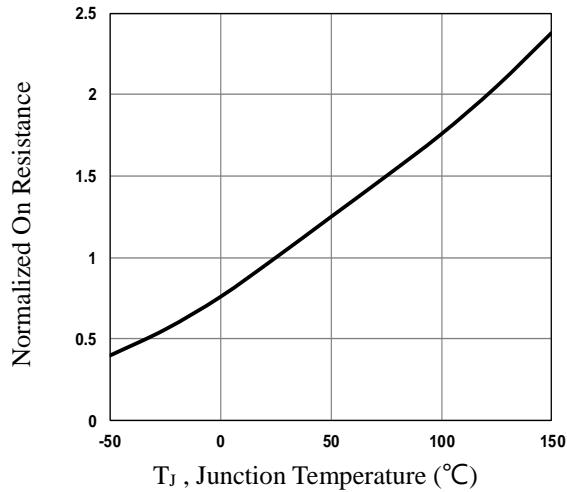
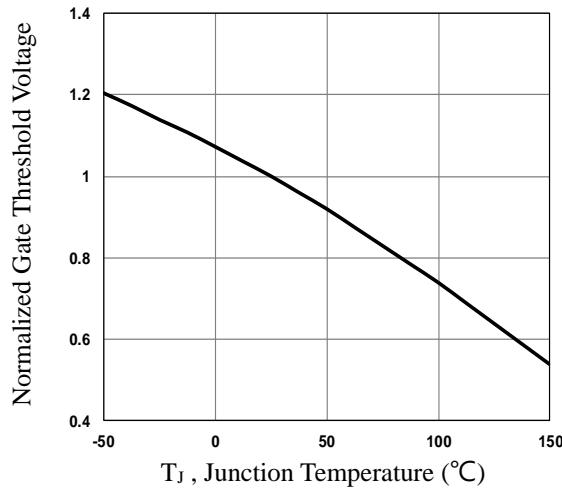
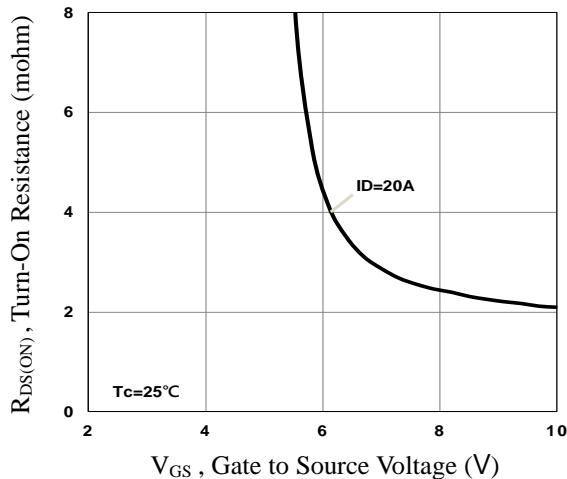
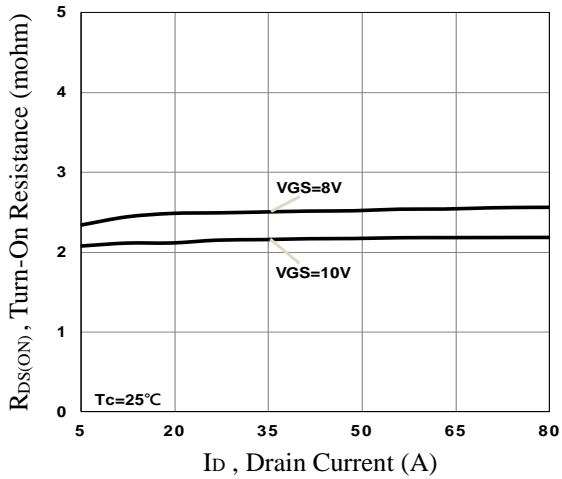
Q_g	Total Gate Charge ^{3, 4}	$V_{DS}=20\text{V}$, $V_{GS}=10\text{V}$, $I_D=85\text{A}$	---	38	60	nC
Q_{gs}	Gate-Source Charge ^{3, 4}		---	13	20	
Q_{gd}	Gate-Drain Charge ^{3, 4}		---	12	20	
$T_{d(on)}$	Turn-On Delay Time ^{3, 4}	$V_{DD}=20\text{V}$, $V_{GS}=10\text{V}$, $R_G=6\Omega$ $I_D=85\text{A}$	---	8	12	ns
T_r	Rise Time ^{3, 4}		---	12	20	
$T_{d(off)}$	Turn-Off Delay Time ^{3, 4}		---	15	25	
T_f	Fall Time ^{3, 4}		---	20	30	
C_{iss}	Input Capacitance	$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$, $F=1\text{MHz}$	---	2650	4000	pF
C_{oss}	Output Capacitance		---	1130	1700	
C_{rss}	Reverse Transfer Capacitance		---	50	75	
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $F=1\text{MHz}$	---	0.95	---	Ω

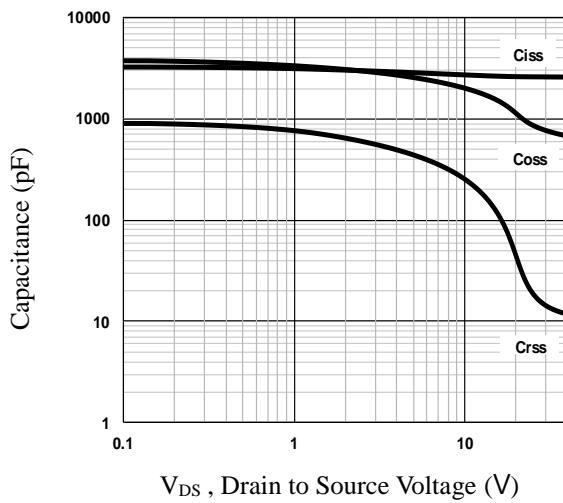
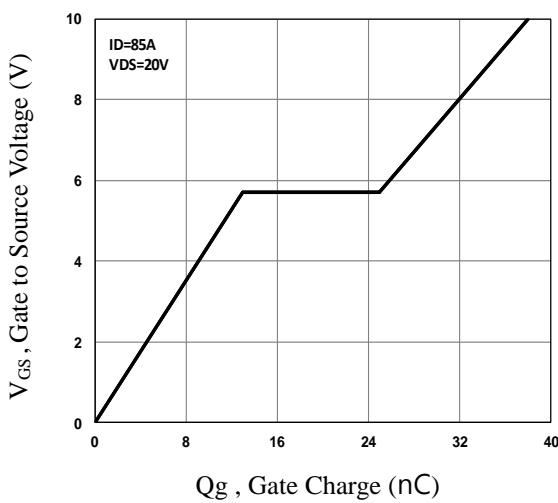
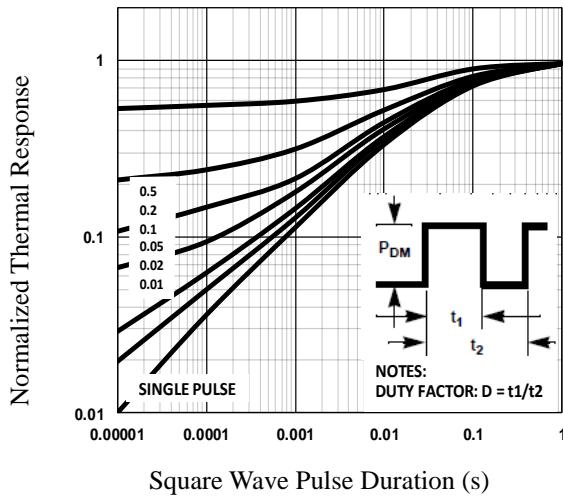
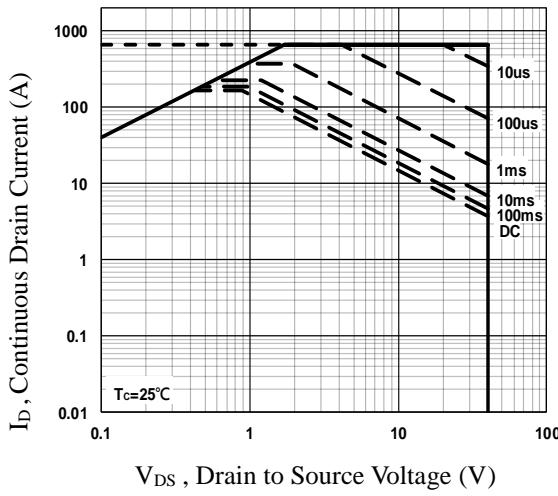
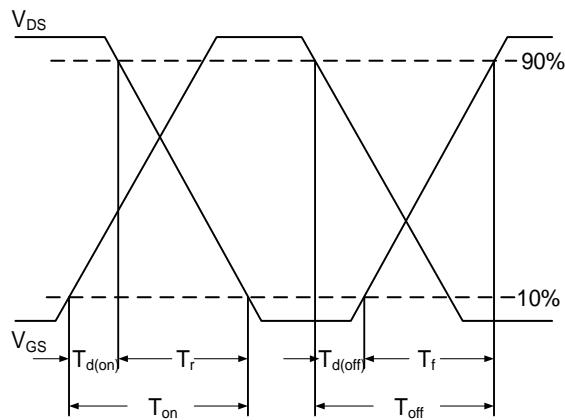
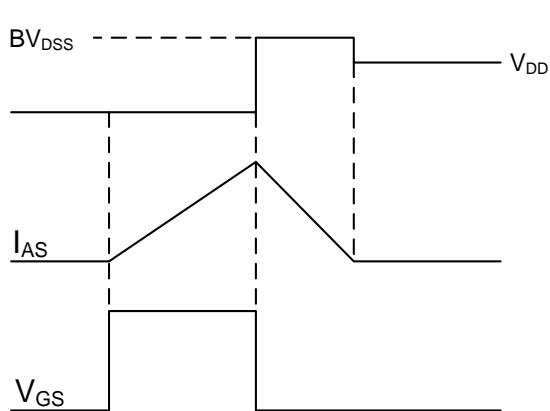
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	170	A
			---	---	340	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}$, $I_s=1\text{A}$, $T_J=25\text{ }^{\circ}\text{C}$	---	---	1	V
T_{rr}	Reverse Recovery Time	$V_R=30\text{V}$, $I_s=10\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$ $T_J=25\text{ }^{\circ}\text{C}$	---	70	---	ns
Q_{rr}	Reverse Recovery Charge		---	100	---	nC

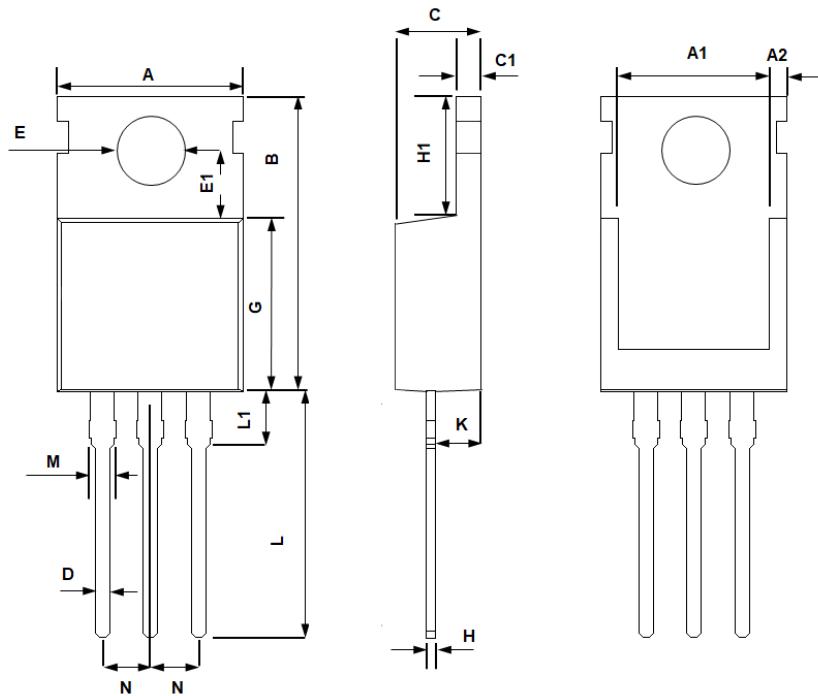
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=25\text{V}$, $V_{GS}=10\text{V}$, $L=0.1\text{mH}$, $I_{AS}=79\text{A}$, $R_G=25\Omega$, Starting $T_J=25\text{ }^{\circ}\text{C}$.
3. The data tested by pulsed , pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.


Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized R_{DSON} vs. T_j

Fig.4 Normalized V_{th} vs. T_j

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 EAS Waveform

TO220 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	10.400	9.700	0.409	0.382
A1	8.900	7.400	0.350	0.291
A2	1.400	0.800	0.055	0.031
B	16.500	14.500	0.650	0.571
C	4.750	4.200	0.187	0.165
C1	1.500	1.100	0.059	0.043
D	1.000	0.600	0.039	0.024
E	4.000	3.300	0.157	0.130
E1	3.800	3.400	0.150	0.134
G	9.400	8.400	0.370	0.331
H	0.600	0.200	0.024	0.008
H1	6.850	6.200	0.270	0.244
K	2.850	2.100	0.112	0.083
L	14.000	12.500	0.551	0.492
L1	4.000	2.700	0.157	0.106
M	1.750	1.100	0.069	0.043
N	2.640	2.440	0.104	0.096